

Differences Between PCM2900B and PCM2900

Consumer Audio Products

ABSTRACT

This letter summarizes the specification differences between the PCM2900B and the PCM2900 stereo audio codec devices from Texas Instruments. TI recommends that customers migrate to the PCM2900B in place of the PCM2900.

1 Summary of Descriptor and Data Sheet Specification Differences Between PCM2900B and PCM2900

Table 1 lists the differences between the PCM2900B and PCM2900 devices in terms of the descriptors reported to the PC during the plug-in sequence and the electrical specifications stated in the product data sheet.

Table 1. PCM2900B and PCM2900 Differences

Parameter	PCM2900BDB	PCM2900E	
USB compliance ⁽¹⁾	0x0200 (USB2.0)	0x0110 (USB1.1)	
Product ID ⁽¹⁾	0x29B0	0x2900	
Alternate setting of Interface #01 ⁽¹⁾	#00/01/02/03/04	#00/01/02/03/04/05/06	
Supply current during Suspend Mode ⁽²⁾	250 μ A (typ)	210 μ A (typ)	
Power dissipation during Suspend Mode ⁽²⁾	1.25 mW (typ)	1.05 mW (typ)	
Internal power-supply voltage ⁽²⁾	Min	3.1 V	3.25 V
	Typ	3.3 V	3.35 V

⁽¹⁾ Descriptor and specification change.

⁽²⁾ Specification change only.

2 Changes from PCM2900 to PCM2900B

This section explains the changes to the PCM2900B from the PCM2900 that result in the differences summarized in Section 1.

1. Change model name and applicable version in USB compliance.

Change the model name from *PCM2900E* to *PCM2900BDB*, and change the applicable version USB compliance to USB2.0 from USB1.1.

2. Bug fix (three bugs listed in the data sheet errata document, [SLAZ036A](#)).

The bugs fixed are:

- Fix of over-/undersized packet sending in recording.
- Fix of 1-kHz noise at 16-kHz/16-bits/Mono mode in recording.
- Fix of one-sample interchannel phase error in recording and playback.

3. Remove 8-bit Offset Binary format from playback data format.

Remove Alternate Setting #05 and #06 from Interface#01 for playback. That is, the PCM2900B removes 8-bit Offset Binary format from playback data format in available results.

4. **Change the output voltage of the internal regulators.**

Change the output voltage of the internal regulators to improve the temperature dependency of power dissipation during suspend mode.

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

TI products are not authorized for use in safety-critical applications (such as life support) where a failure of the TI product would reasonably be expected to cause severe personal injury or death, unless officers of the parties have executed an agreement specifically governing such use. Buyers represent that they have all necessary expertise in the safety and regulatory ramifications of their applications, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of TI products in such safety-critical applications, notwithstanding any applications-related information or support that may be provided by TI. Further, Buyers must fully indemnify TI and its representatives against any damages arising out of the use of TI products in such safety-critical applications.

TI products are neither designed nor intended for use in military/aerospace applications or environments unless the TI products are specifically designated by TI as military-grade or "enhanced plastic." Only products designated by TI as military-grade meet military specifications. Buyers acknowledge and agree that any such use of TI products which TI has not designated as military-grade is solely at the Buyer's risk, and that they are solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI products are neither designed nor intended for use in automotive applications or environments unless the specific TI products are designated by TI as compliant with ISO/TS 16949 requirements. Buyers acknowledge and agree that, if they use any non-designated products in automotive applications, TI will not be responsible for any failure to meet such requirements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

Products

Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
RF/IF and ZigBee® Solutions	www.ti.com/lprf

Applications

Audio	www.ti.com/audio
Automotive	www.ti.com/automotive
Broadband	www.ti.com/broadband
Digital Control	www.ti.com/digitalcontrol
Medical	www.ti.com/medical
Military	www.ti.com/military
Optical Networking	www.ti.com/opticalnetwork
Security	www.ti.com/security
Telephony	www.ti.com/telephony
Video & Imaging	www.ti.com/video
Wireless	www.ti.com/wireless

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265
Copyright © 2009, Texas Instruments Incorporated